



Thyristor Modules

SKKT 140/16 E

Features*

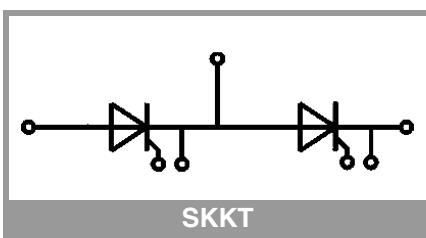
- Heat transfer through aluminium oxide ceramic insulated metal baseplate
- UL recognized, file no. E63532

Typical Applications

- Fully controlled rectifiers
- AC motor soft starters
- AC power regulation
- AC switch

Absolute Maximum Ratings		Values		Unit
Symbol	Conditions			
Chip				
$I_{T(AV)}$	sin. 180° $T_j = 130 \text{ }^\circ\text{C}$	$T_c = 85 \text{ }^\circ\text{C}$ $T_c = 100 \text{ }^\circ\text{C}$	145 110	A A
I_{TSM}	$t_p = 10 \text{ ms}$	$T_j = 25 \text{ }^\circ\text{C}$ $T_j = 130 \text{ }^\circ\text{C}$	2600 2210	A A
i^2t	$t_p = 10 \text{ ms}$	$T_j = 25 \text{ }^\circ\text{C}$ $T_j = 130 \text{ }^\circ\text{C}$	33800 24421	A^2s A^2s
V_{RSM}	$T_j = 25 \text{ }^\circ\text{C}$		1700	V
V_{RRM}	$T_j = 25 \text{ }^\circ\text{C}$		1600	V
V_{DRM}	$T_j = 25 \text{ }^\circ\text{C}$		1600	V
$(di/dt)_{cr}$	$T_j = 130 \text{ }^\circ\text{C}$		200	$\text{A}/\mu\text{s}$
$(dv/dt)_{cr}$	$T_j = 130 \text{ }^\circ\text{C}$		1000	$\text{V}/\mu\text{s}$
T_j			-40 ... 130	$^\circ\text{C}$
Module				
T_{stg}			-40 ... 125	$^\circ\text{C}$
V_{isol}	a.c.; 50 Hz; r.m.s.	1 min 1 s	3000 3600	V V

Characteristics		min.	typ.	max.	Unit
Symbol	Conditions				
Chip					
V_T	$T_j = 25 \text{ }^\circ\text{C}$, $I_T = 420 \text{ A}$			1.85	V
$V_{T(TO)}$	$T_j = 130 \text{ }^\circ\text{C}$			0.90	V
r_T	$T_j = 130 \text{ }^\circ\text{C}$			2.6	$\text{m}\Omega$
I_{DD}, I_{RD}	$T_j = 130 \text{ }^\circ\text{C}$, $V_{DD} = V_{DRM}$; $V_{RD} = V_{RRM}$			20	mA
t_{gd}	$I_G = 1 \text{ A}$ $di_G/dt = 1 \text{ A}/\mu\text{s}$	$T_j = 25 \text{ }^\circ\text{C}$		1	μs
t_{gr}	$V_D = 0.67 * V_{DRM}$	$T_j = 25 \text{ }^\circ\text{C}$		2	μs
t_q	$T_j = 130 \text{ }^\circ\text{C}$			200	μs
I_H	$T_j = 25 \text{ }^\circ\text{C}$			220	mA
I_L	$T_j = 25 \text{ }^\circ\text{C}$, $R_G = 33 \Omega$			550	mA
V_{GT}	$T_j = 25 \text{ }^\circ\text{C}$, d.c.		2.5		V
I_{GT}	$T_j = 25 \text{ }^\circ\text{C}$, d.c.		100		mA
V_{GD}	$T_j = 130 \text{ }^\circ\text{C}$, d.c.			0.25	V
I_{GD}	$T_j = 130 \text{ }^\circ\text{C}$, d.c.			4	mA
$R_{th(j-c)}$	cont.	per chip per module		0.13 0.065	K/W
$R_{th(j-c)}$	sin. 180°	per chip per module		0.17 0.085	K/W
$R_{th(j-c)}$	rec. 120°	per chip per module		0.18 0.09	K/W
Module					
$R_{th(c-s)}$	chip, P12 (reference)		0.09		K/W
	module, P12 (reference)		0.05		K/W
M_s	to heatsink M5		4.25	5.75	Nm
M_t	to terminals M5		2.55	3.45	Nm
a				5 * 9.81	m/s^2
w			75		g



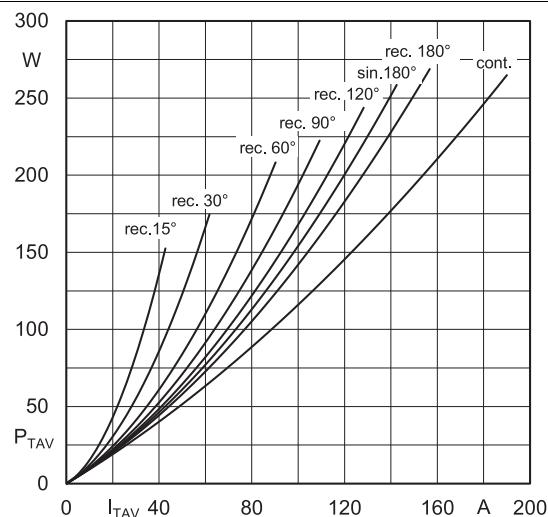


Fig. 1L: Max. power dissipation per chip vs. on-state current

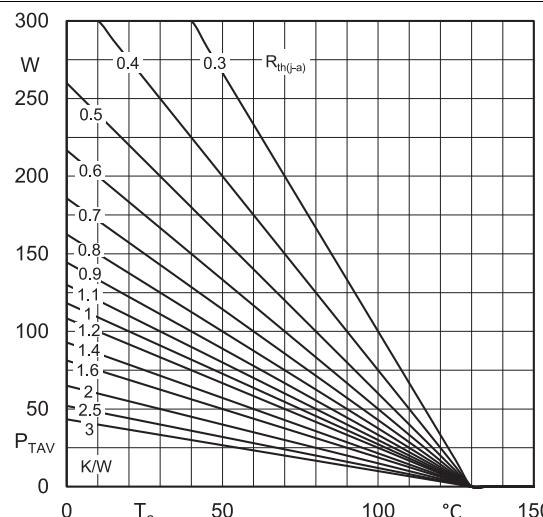


Fig. 1R: Max. power dissipation per chip vs. ambient temperature

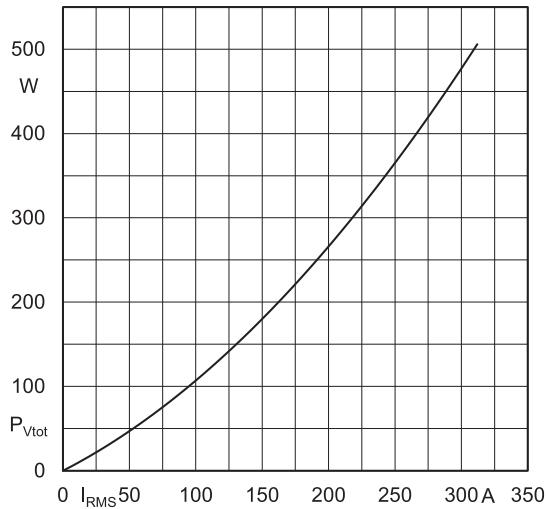


Fig. 2L: Max. power dissipation of one module vs. rms current

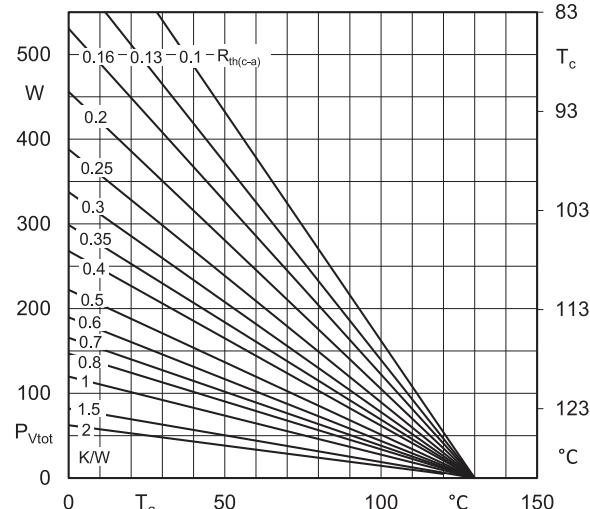


Fig. 2R: Max. power dissipation of one module vs. ambient temperature

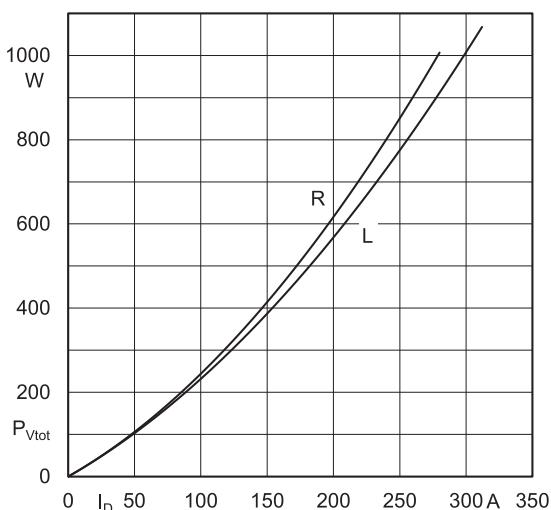


Fig. 3L: Max. power dissipation of two modules vs. direct current

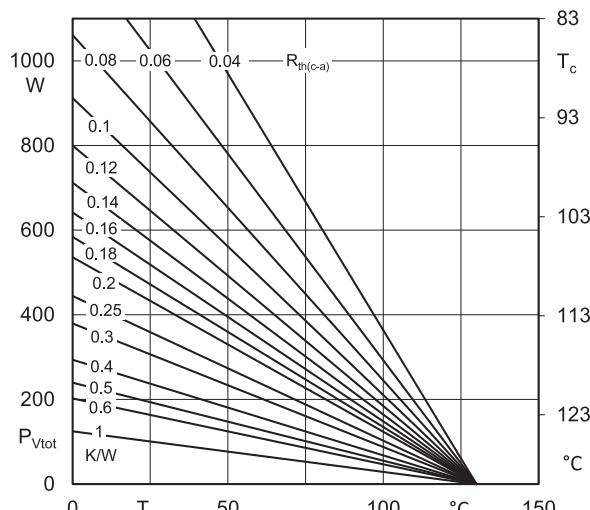


Fig. 3R: Max. power dissipation of two modules vs. ambient temperature

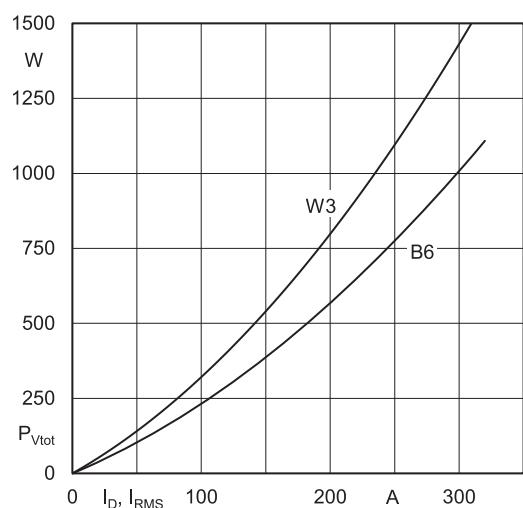


Fig. 4L: Max. power dissipation of three modules vs. direct current

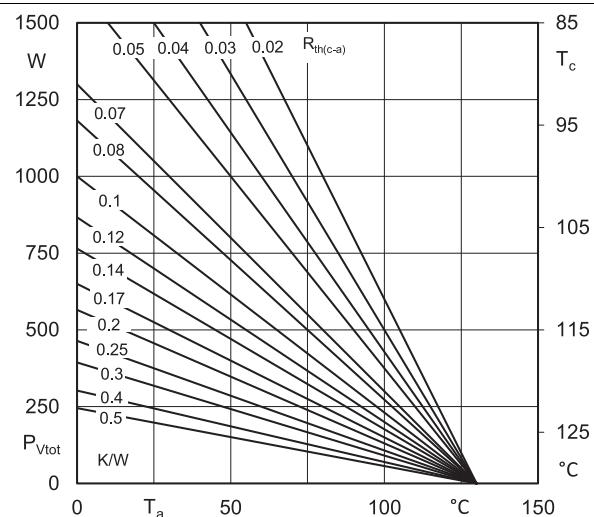


Fig. 4R: Max. power dissipation of three modules vs. ambient temperature

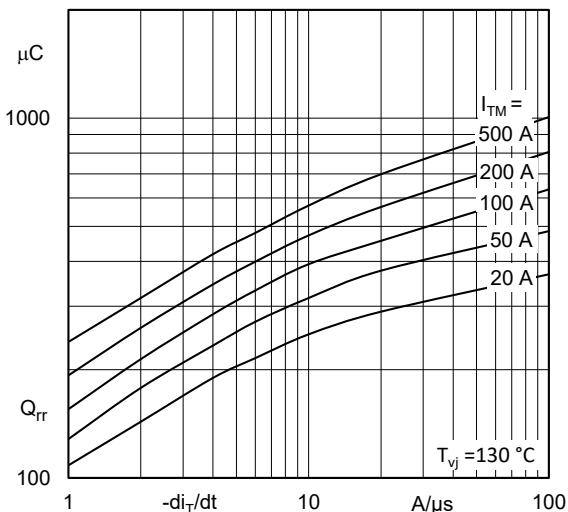


Fig. 5: Recovered charge vs. current decrease

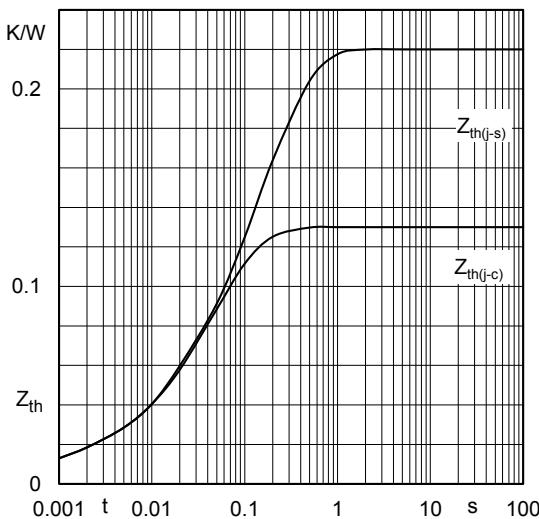


Fig. 6: Transient thermal impedance vs. time

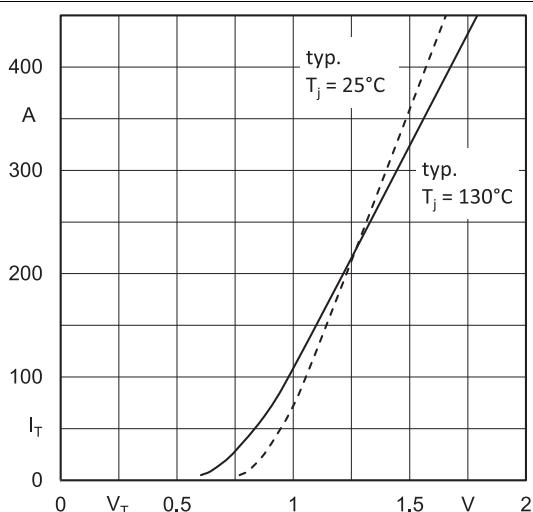


Fig. 7: On-state characteristics

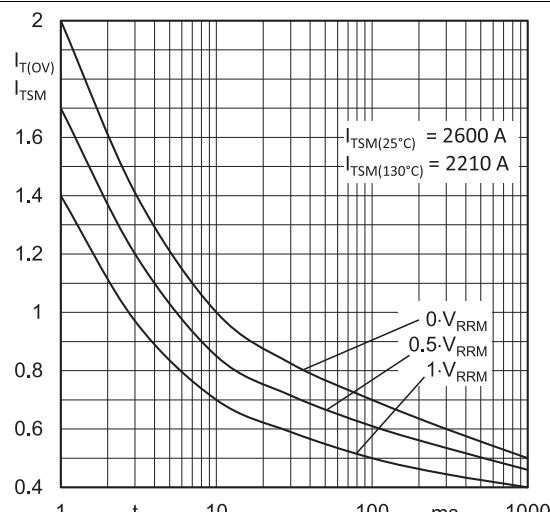


Fig. 8: Surge overload current vs. time

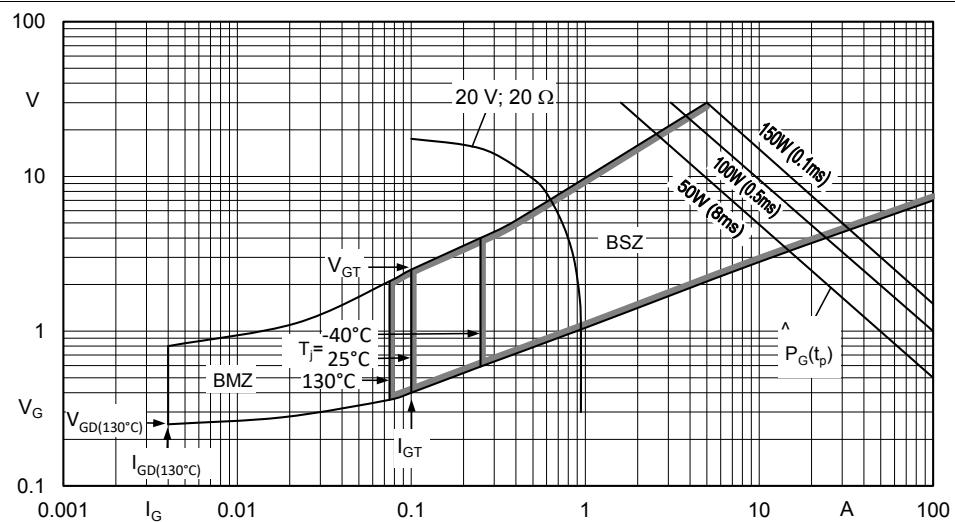
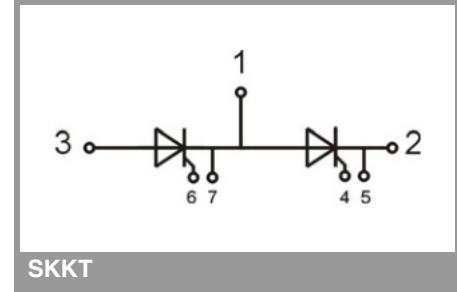
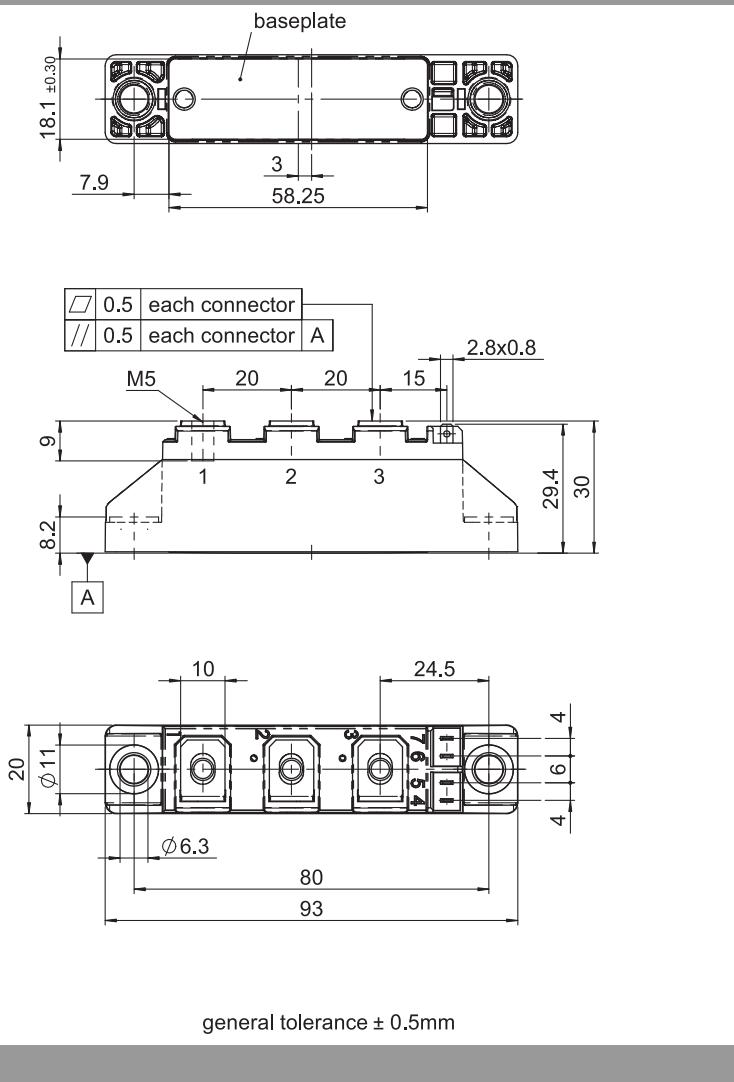


Fig. 9: Gate trigger characteristics



SEMIPACK 1

IMPORTANT INFORMATION AND WARNINGS

This is an electrostatic discharge sensitive device (ESDS) according to international standard IEC 61340.

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